IGBT - Power, Co-PAK, **N-Channel, Field Stop VII** (FS7), SCR, Power TO247-4L 1200 V, 1.45 V, 40 A AFGH4L40T120RWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 4-lead package, this device offers the optimum performance with low on state voltage and minimal switching losses for both hard and soft switching topologies in automotive applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature $T_I = 175^{\circ}C$
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- These Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive E-compressor
- Automotive EV PTC Heater
- OBC

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

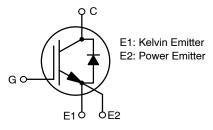
		-		
Parame	Symbol	Value	Unit	
Collector-to-Emitter Vol	V _{CE}	1200	V	
Gate-to-Emitter Voltage	•	V _{GE}	±20	
Transient Gate-to-Emitt	er Voltage	1	±30	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	۱ _C	80	А
	$T_{\rm C} = 100^{\circ}{\rm C}$	1	40	
Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	576	W
	$T_{\rm C} = 100^{\circ}{\rm C}$		288	
Pulsed Collector Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{CM}	120	A
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	80	
	$T_{\rm C} = 100^{\circ}{\rm C}$	1	40	
Pulsed Diode Forward Current	T _C = 25°C, t _p = 10 μs (Note 1)	I _{FM}	120	
Short Circuit Withstand T $V_{GE} = 15 \text{ V}, \text{ V}_{CC} = 800 \text{ V}$	T _{SC}	6	μs	
Operating Junction and S Range	T _J , T _{stg}	-55 to +175	°C	
Lead Temperature for So	ΤL	260		

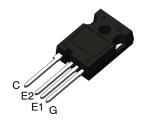
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature

BV _{CES}	VCE _(sat) TYP	I _C MAX
1200 V	1.45 V	40 A

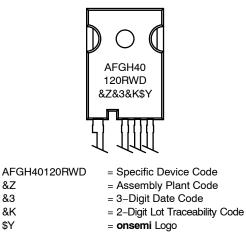
PIN CONNECTIONS





TO-247-4LD CASE 340CJ

MARKING DIAGRAM



ORDERING INFORMATION

&7

&3

&K

\$Y

Device	Package	Shipping
AFGH4L40T120RWD	TO-247-4L (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.26	°C/W
Thermal Resistance, Junction-to-Case for Diode	$R_{\theta JC}$	0.46	1
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

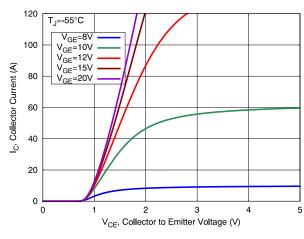
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•		-		•
Collector-to-Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA	1200	-	-	V
Collector-to-Emitter Breakdown Voltage Temperature Coefficient	$\Delta BV_{CES} / \Delta T_{J}$	V _{GE} = 0 V, I _C = 9.99 mA	-	1226	-	mV/°C
Zero Gate Voltage Collector Current	ICES	V_{GE} = 0 V, V_{CE} = V_{CES}	-	-	40	μΑ
Gate-to-Emitter leakage Current	I _{GES}	V_{GE} = ±20 V, V_{CE} = 0 V	Ι	-	±400	nA
ON CHARACTERISTICS						
Gate-to-Emitter Threshold Voltage	V _{GE(th)}	V_{GE} = V_{CE} , I_C = 40 mA, T_J = 25°C	4.98	5.88	6.78	V
Collector-to-Emitter Saturation Voltage	V _{CE(sat)}	V_{GE} = 15 V, I_C = 40 A, T_J = 25°C	-	1.45	1.78	V
		V_{GE} = 15 V, I _C = 40 A, T _J = 175°C	-	1.75	-	
DYNAMIC CHARACTERISTICS					-	
Input Capacitance	CIES	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	4713	-	pF
Output Capacitance	C _{OES}		-	195	-	pF
Reverse Transfer Capacitance	C _{RES}		-	23.8	-	pF
Total Gate Charge	Q _G	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 15 \text{ V},$ $I_{C} = 40 \text{ A}$	-	171	-	nC
Gate-to-Emitter Charge	Q _{GE}	I _C = 40 A	-	42.2	-	nC
Gate-to-Collector Charge	Q _{GC}		-	73.1	-	nC
SWITCHING CHARACTERISTICS					-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 V$ $V_{GE} = 0/15 V$ $I_{C} = 20 A$ $R_{G} = 6 \Omega$ $T_{J} = 25^{\circ}C$	-	53.5	-	ns
Turn-Off Delay Time	t _{d(off)}		-	311	-	
Rise Time	tr		-	27.8	-	
Fall Time	t _f		-	189	-	
Turn-On Switching Loss	E _{on}		-	1.26	-	mJ
Turn-Off Switching Loss	E _{off}		-	1.36	-	1
Total Switching Loss	E _{ts}		-	2.61	-	
Turn–On Delay Time	t _{d(on)}	V _{CE} = 600 V	-	58.2	-	ns
Turn-Off Delay Time	t _{d(off)}	$V_{GE} = 0/15 V$ $I_{C} = 40 A$ $R_{G} = 6 \Omega$ $T_{J} = 25^{\circ}C$	-	258	-	
Rise Time	tr		-	47.4	-	
Fall Time	t _f		-	122	-	
Turn-On Switching Loss	E _{on}	1	-	3.38	-	mJ
Turn-Off Switching Loss	E _{off}	1	-	1.7	-	
Total Switching Loss	E _{ts}	1	-	5.08	_	1

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS	· ·		•	•		<u></u>
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 V$ $V_{GE} = 0/15 V$ $I_{C} = 20 A$	-	58.7	-	ns
Turn-Off Delay Time	t _{d(off)}		-	433	-	
Rise Time	t _r	Ř _G = 6 Ω T _J = 175°C	-	39.4	-	
Fall Time	t _f	1) = 170 0	-	376	-	
Turn–On Switching Loss	E _{on}		-	2.01	-	mJ
Turn-Off Switching Loss	E _{off}		-	2.52	-	I
Total Switching Loss	E _{ts}		-	4.53	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 V$	-	65.7	-	ns
Turn-Off Delay Time	t _{d(off)}	V _{GE} = 0/15 V I _C = 40 A	-	343	-	
Rise Time	t _r	R _G = 6 Ω Τ _J = 175°C	-	64.7	_	1
Fall Time	t _f		-	233	_	
Turn–On Switching Loss	E _{on}		-	5.45	_	mJ
Turn–Off Switching Loss	E _{off}		-	3.04	_	
Total Switching Loss	E _{ts}		-	8.49	_	
DIODE CHARACTERISTICS						
Diode Forward Voltage	V _F	$V_{F} = I_{F} = 40 \text{ A}, T_{J} = 25^{\circ}\text{C}$ $I_{F} = 40 \text{ A}, T_{J} = 175^{\circ}\text{C}$	-	1.55	1.85	V
			-	1.54	-	
DIODE SWITCHING CHARACTERISTIC	S, INDUCTIVE LOAD					
Reverse Recovery Time	t _{rr}	V _R = 600 V, I _F = 20 A,	-	145	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs T _J = 25°C	-	2055	-	nC
Reverse Recovery Energy	E _{rec}		-	0.49	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	34	-	А
Reverse Recovery Time	t _{rr}	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A}, \\ dI_{F}/dt = 500 \text{ A}/\mu s \\ T_{J} = 25^{\circ}\text{C}$	-	182	-	ns
Reverse Recovery Charge	Q _{rr}		-	3527	-	nC
Reverse Recovery Energy	E _{rec}		-	0.67	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	43.5	-	А
Reverse Recovery Time	t _{rr}	$V_{R} = 600 \text{ V}, I_{F} = 20 \text{ A},$	-	204	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs T _J = 175°C	-	3606	-	nC
Reverse Recovery Energy	E _{rec}		-	1.07	-	mJ
Peak Reverse Recovery Current	I _{RRM}		_	42.3	-	А
Reverse Recovery Time	t _{rr}	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$	-	253	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/μs T _J = 175°C	_	6542	-	nC
Reverse Recovery Energy	E _{rec}		_	1.52	_	mJ
The verse Theoremy Energy	100					

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





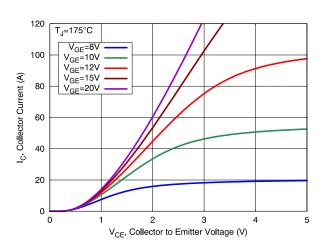


Figure 3. Output Characteristics

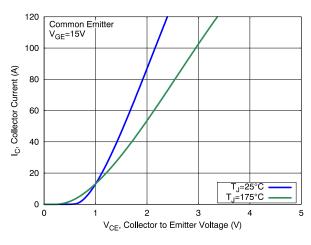
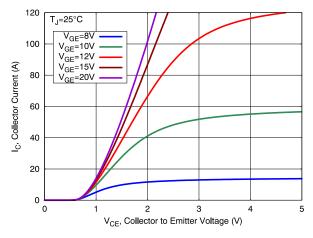


Figure 5. Saturation Characteristics





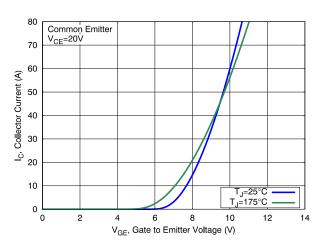
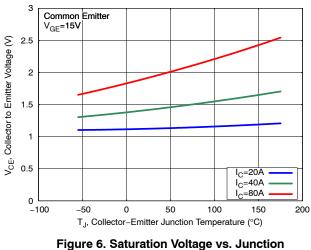
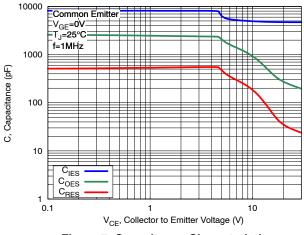


Figure 4. Transfer Characteristics

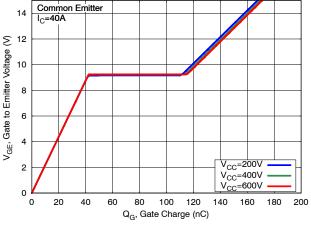


Temperature

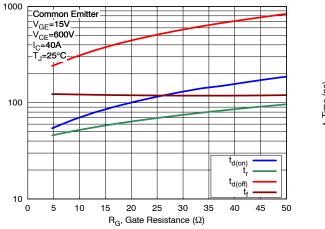
TYPICAL CHARACTERISTICS











t, Time (ns)

Figure 9. Switching Time vs Gate Resistance

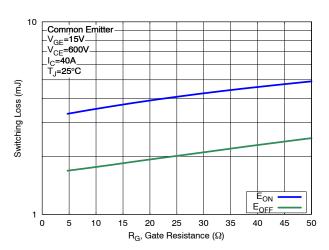


Figure 11. Switching Loss vs Gate Resistance

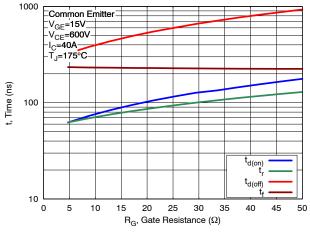
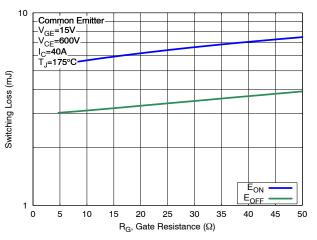


Figure 10. Switching Time vs Gate Resistance





TYPICAL CHARACTERISTICS

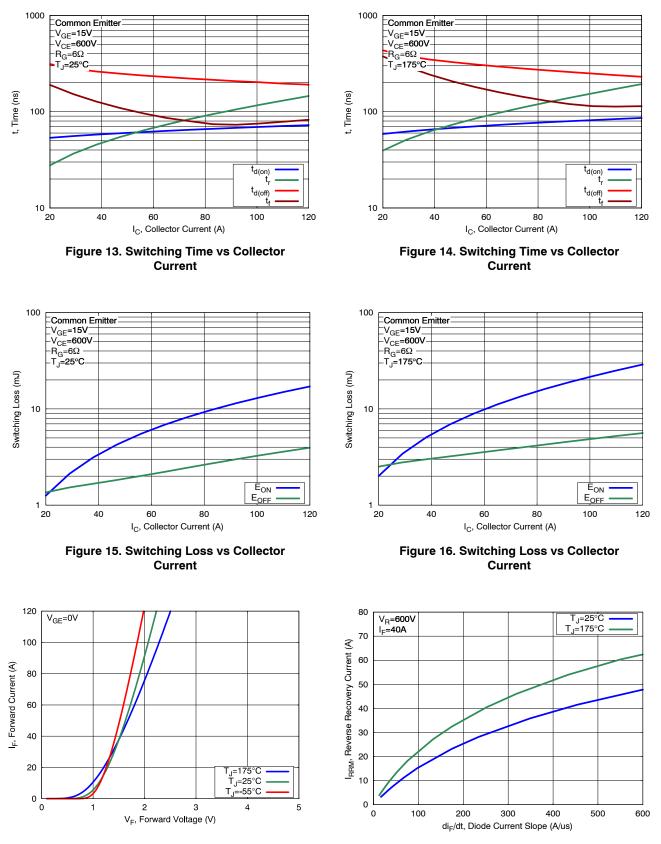


Figure 17. Diode Forward Characteristics

Figure 18. Diode Reverse Recovery Current

TYPICAL CHARACTERISTICS

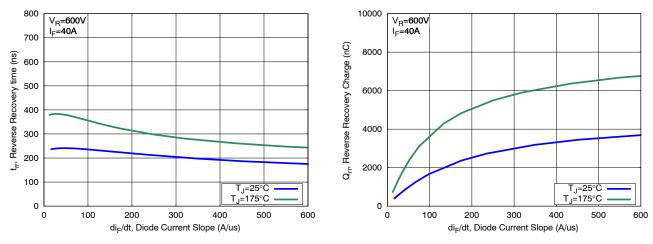
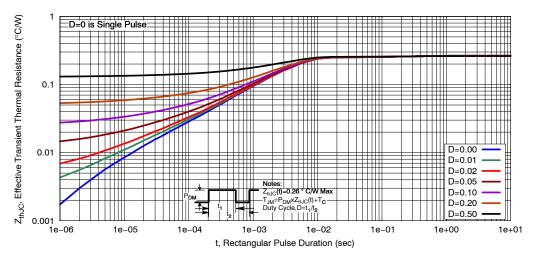
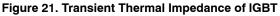


Figure 19. Diode Reverse Recovery Time

Figure 20. Diode Stored Charge Characteristics





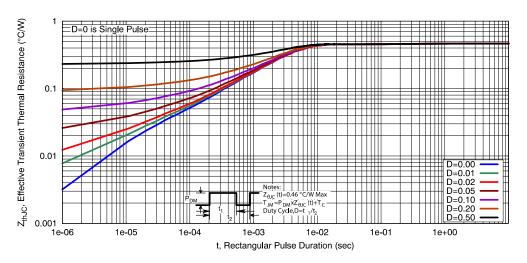


Figure 22. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

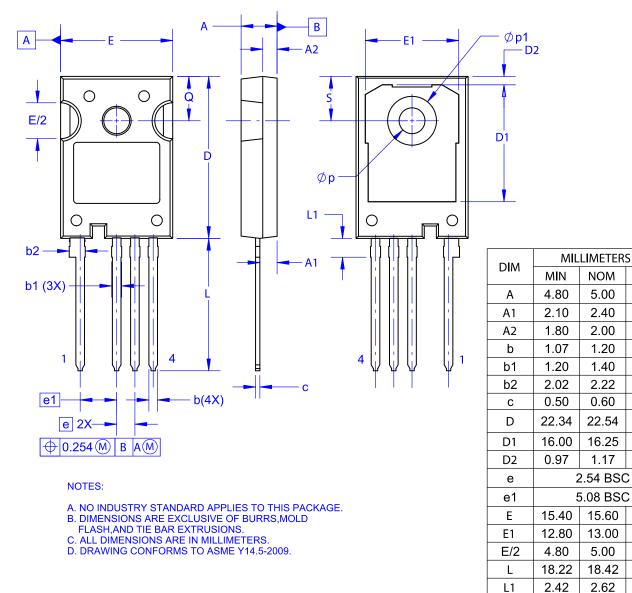
18.62

2.82

3.80

7.00 6.37

6.37



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